

# PRM012N10S8

# PFC Device Corporation

# 100V Single N-Channel MOSFET

# Major ratings and characteristics

Characteristics	Values	Units
$V_{DS}$	100	V
I <sub>D</sub> (T <sub>A</sub> =25°C)	10.7	Α
Max. R <sub>DS(ON)</sub> @V <sub>GS</sub> =10V	12	mΩ
Max. R <sub>DS(ON)</sub> @V <sub>GS</sub> =4.5V	15	mΩ
T <sub>J</sub> Operating Junction Temperature	-55 to +150	°C

# **General Description**

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.

# PRM012N10S8 SOP-8

# **Typical Applications**

- Charger Adapter
- Power Tools
- LED Lighting

### **Features**

- Max.  $R_{DS(ON)}=12m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- 100% E<sub>AS</sub> Guaranteed
- Green Device Available

# 1. Characteristics

### **Maximum Ratings Characteristics**

( $T_A = 25$  °C unless otherwise specified)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	±20	V
	Drain Current – Continuous (T <sub>A</sub> =25°C)	10.7	Α
I <sub>D</sub>	Drain Current – Continuous (T <sub>A</sub> =100°C)	6.7	А
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	42.8	А
$E_AS$	Single Pulse Avalanche Energy <sup>2</sup>	58	mJ
$I_{AS}$	Single Pulse Avalanche Current <sup>2</sup>	17	Α
В	Power Dissipation (T <sub>A</sub> =25°C)	2.5	W
$P_{D}$	Power Dissipation – Derate above 25°C	0.02	W/°C
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		50	°C/W



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### **Electrical Characteristics**

( $T_J = 25$  °C unless otherwise specified)

### Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}$ =0V, $I_D$ =250uA	100			V
	Drain Source Leekage Current	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C			1	uA
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C			250	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm20V, V_{DS}=0V$			±100	nA

### On Characteristics

D	Static Drain-Source On-Resistance	$V_{GS}$ =10V, $I_D$ =5A			12	mΩ
$R_{DS(ON)}$		V <sub>GS</sub> =4.5V, I <sub>D</sub> =3A	-		15	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_{D}=250uA$	1.0		2.5	V
<b>g</b> fs	Forward Transconductance	$V_{DS}$ =5V, $I_{D}$ =5A		25		S

**Dynamic and switching Characteristics** 

$Q_g$	Total Gate Charge <sup>3,4</sup>		 36.5	
$Q_gs$	Gate-Source Charge <sup>3,4</sup>	$V_{DS}$ =50V, $V_{GS}$ =10V, $I_{D}$ =10.7A	 6.5	 nC
$Q_gd$	Gate-Drain Charge <sup>3, 4</sup>		 6.5	
$T_{d(on)}$	Turn-On Delay Time <sup>3, 4</sup>		 14	
T <sub>r</sub>	Turn-On Rise Time <sup>3, 4</sup>	$V_{DD}$ =50V, $V_{GS}$ =10V, $R_{G}$ =6 $\Omega$ $I_{D}$ =10.7A	 42	 ns
$T_{d(off)}$	Turn-Off Delay Time <sup>3, 4</sup>		 41	 115
$T_f$	Turn-Off Fall Time <sup>3, 4</sup>		 82	
$C_{iss}$	Input Capacitance		 2200	
$C_{oss}$	Output Capacitance	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz	 210	 pF
$C_{rss}$	Reverse Transfer Capacitance		 30	
$R_{g}$	Gate resistance	$V_{GS}$ =0V, $V_{DS}$ =0V, f=1MHz	 1.6	 Ω

### **Drain-Source Diode Characteristics**

$V_{\text{SD}}$	Source to Drain Diode Voltage	$V_{GS}$ =0V, $I_{S}$ =10.7A			1.5	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>s</sub> =10.7A, di/dt=100A/us	1	46	1	ns
$Q_{rr}$	Reverse Recovery Charge	15=10.7A, di/dl=100A/dS		63	-	nC

### Note:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2.  $V_{DD}$ =50V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =27A,  $R_G$ =25 $\Omega$ , Starting  $T_J$ =25 $^{\circ}$ C
- 3. The data tested by pulsed, pulse width  $\leq$ 300us, duty cycle  $\leq$ 2%.
- 4. Essentially independent of operating temperature.



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# 2. Characteristics Curves

# **Ratings and Characteristics Curves**

### (T<sub>A</sub> = 25°C unless otherwise specified)

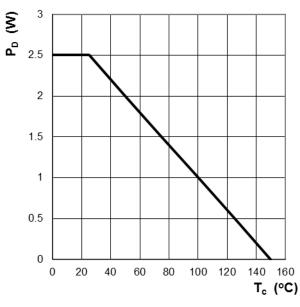


Figure 1: Power Dissipation

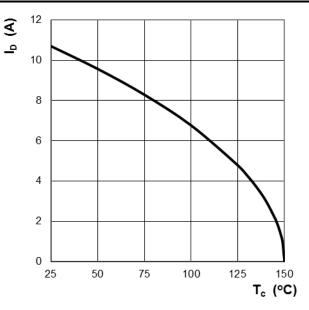


Figure 2: Continuous Drain Current vs. T<sub>C</sub>

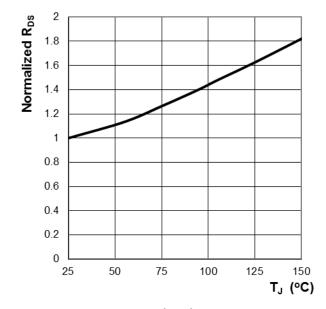


Figure 3: Normalized R<sub>DS(ON)</sub> vs. T<sub>J</sub>

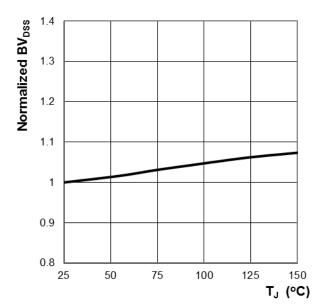


Figure 4: Normalized BV<sub>DSS</sub> vs. T<sub>J</sub>

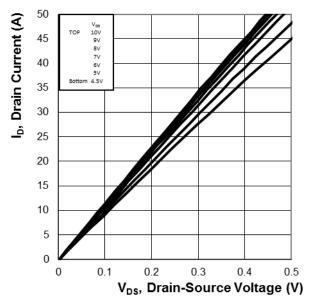


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### **Ratings and Characteristics Curves**

# ( T<sub>A</sub> = 25° unless otherwise specified )



**Figure 5: On-Region Characteristics** 

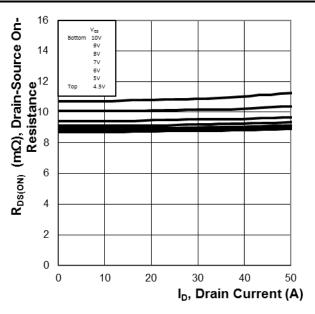


Figure 6: Typ.  $R_{DS}$  Variation vs.  $I_D$  and  $V_{GS}$ 

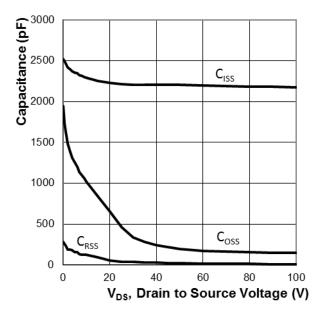
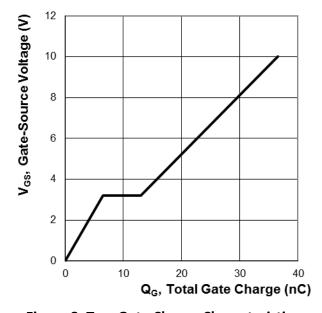


Figure 7: Typ. Capacitance Characteristics



**Figure 8: Typ. Gate Charge Characteristics** 



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### **Ratings and Characteristics Curves**

(T<sub>A</sub> = 25°C unless otherwise specified)

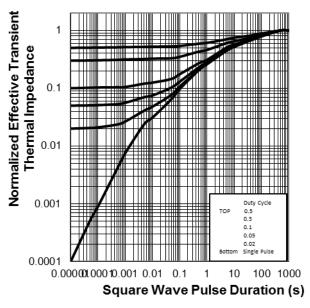


Figure 9: Normalized Thermal Transient Impedance, Junction-to-Case

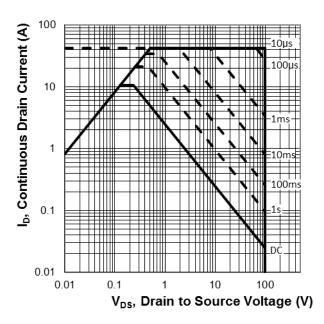


Figure 10: Maximum Safe Operation Area



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# 3. Marking information

**Top Marking Rule** 

PFC PRM 012N10S8 YYWW ABSH

PRM012N10S8 = Product Type Marking Code

YYWW = Date Code

YY = Last two digits of year

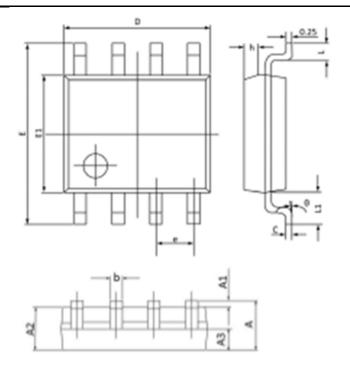
WW = Week code

ABS = Assembly code

H = Halogen Free (N/A = common molding compound)

# 4. Package information

### Package Outline Dimensions millimeters



Dim.	Min.	Max.		
A	1.35	1.75		
Al	0.10	0.25		
A2	1.30			
A3	0.60	0.70		
b	0.35	0.49		
С	0.18	0.26		
D	4.70	5.10		
E	5.80	6.20		
E1	3.70 4.10			
e	1.27	BSC		
h	0.25	0.50		
L	0.40	0.90		
Ll	1.05 BSC			
θ	0°	8°		
All Dimensions in mm				



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# 5. Ordering information

Part Number	Package	Delivery mode
PRM012N10S8	SOP-8	3000 pcs / 13" diameter reel

### Mechanical

Molder Plastic : UL Flammability Classification Rating 94V-0

■ Device Weight: 0.003 ounces (0.085grams) – SOP-8

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